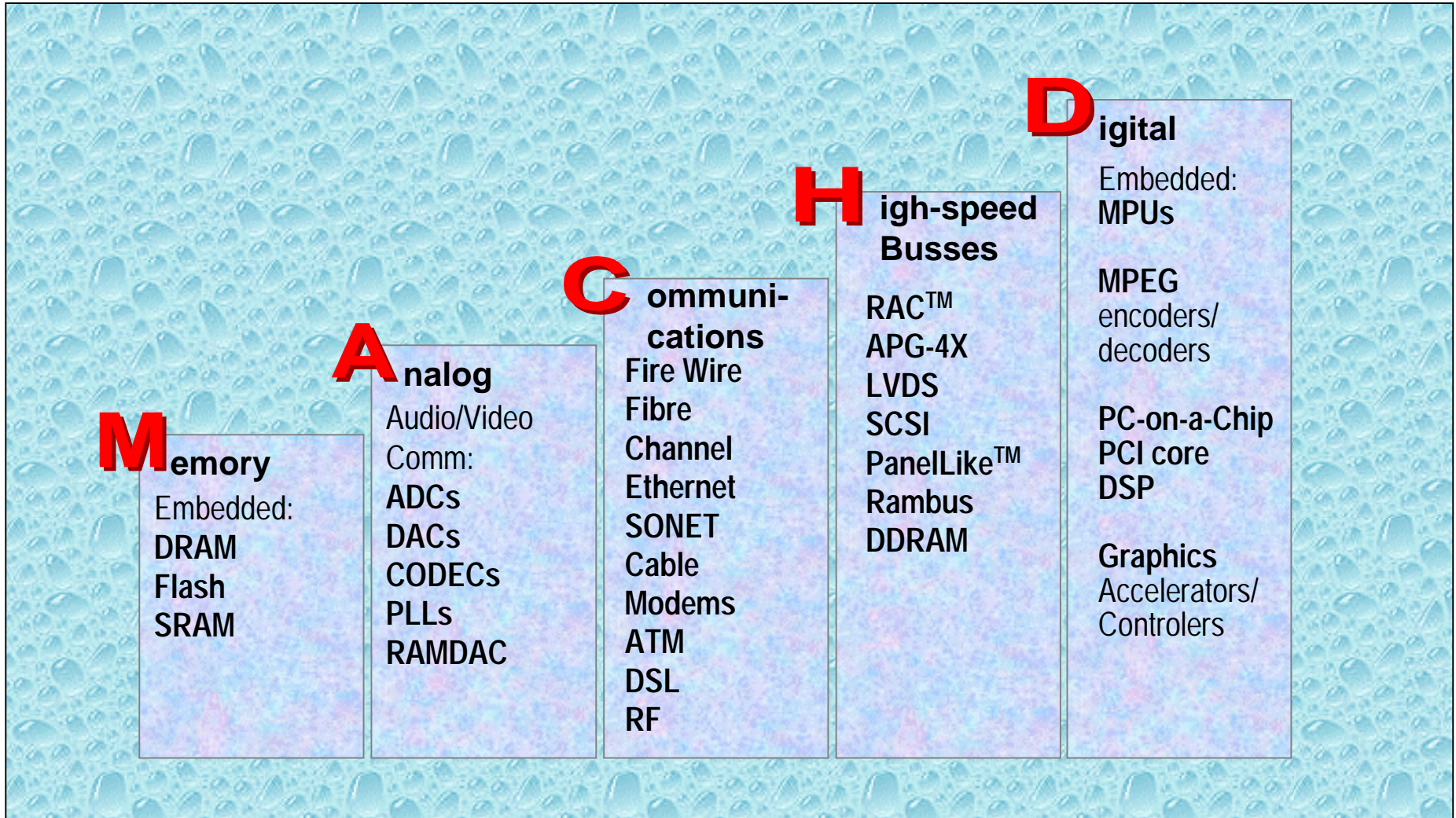


# Automatic Test Equipment

- **General introduction**
  - IC category
  - Tester category
- **ATE Hardware system**
- **Tester example -- DRAM**

# IC category



# Tester category

## Digital

DSP, ASIC, CBIC, ASSP, High pin-count gate Array, MPU, ASIC, SOCRISC, CISC.....

## Mixed-Signal +DC Parameter

Communications 、 Converters 、 Interface 、 Integrated Signal Processing 、 Smart Power 、 and Specialty.....

## Memory

DRAM, ROM, SRAM, SDRAM, Flash Memory, DDR RAM, Rambus,.....

# Tester category & Examples (Advantest)

**SOC Test System** - MPU, ASIC, SOCRISC, CISC..... **T6682 SOC Test System**

**VLSI Test System** - ASIC, CBIC, ASSP, High pin-count gate array..... **T3347B VLSI Test System**

**Memory Test System** - DRAM, DDR, RDRAM, SLDRAM, PBSRAM..... **T5591 Memory Test System**

**Flash Memory Test System** - Flash Memory..... **T5721 Flash Memory Test System**

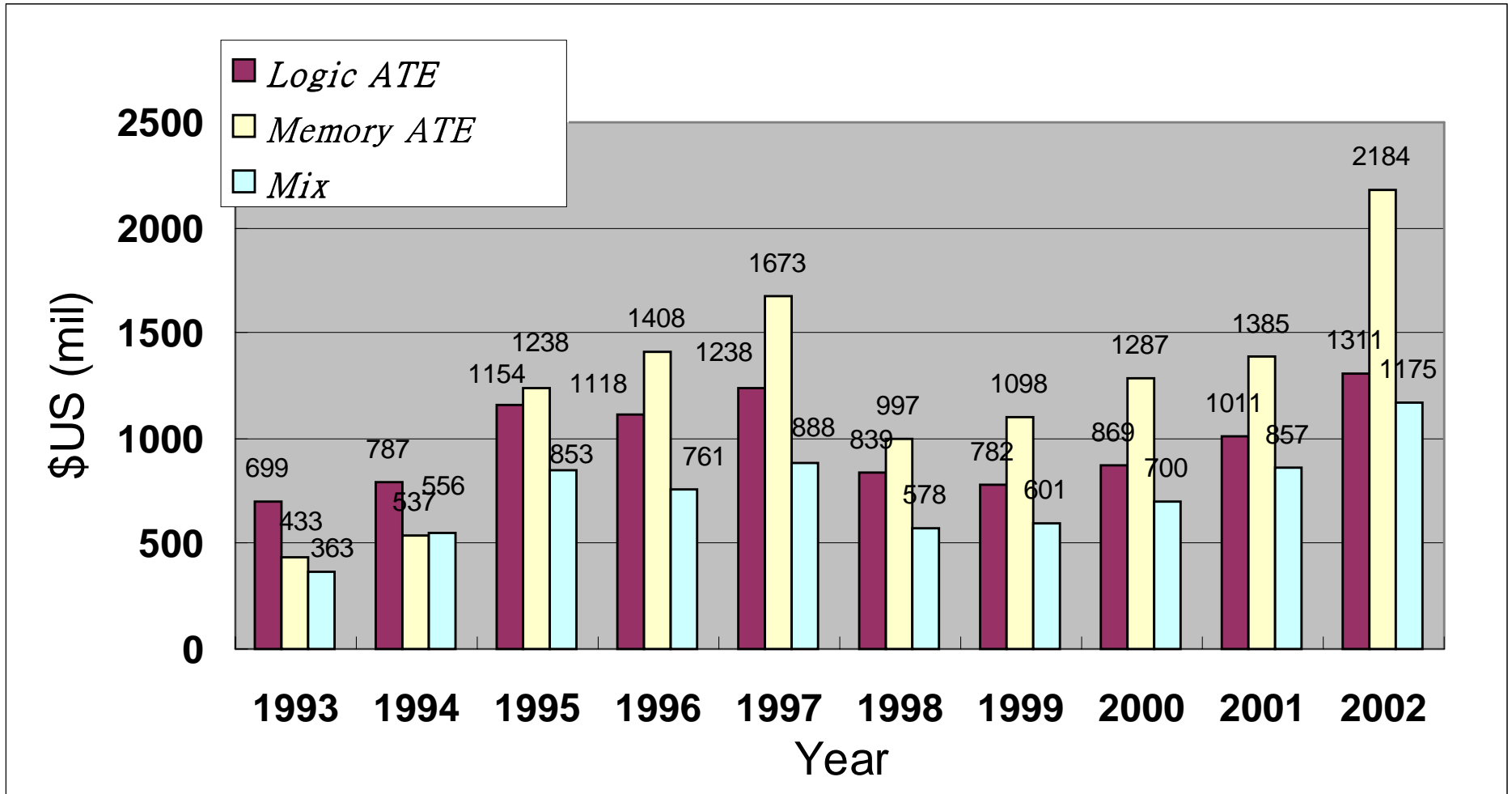
**Mixed-Signal Test System** - Mixed-Signal devices for audio/video, CD-ROM or other PC peripherals, mobile telephone system..... **T7323 Mixed-Signal Test System**

**RFIC Test System** - RFIC used in various types of radio communications..... **T7610 RFIC Test System**

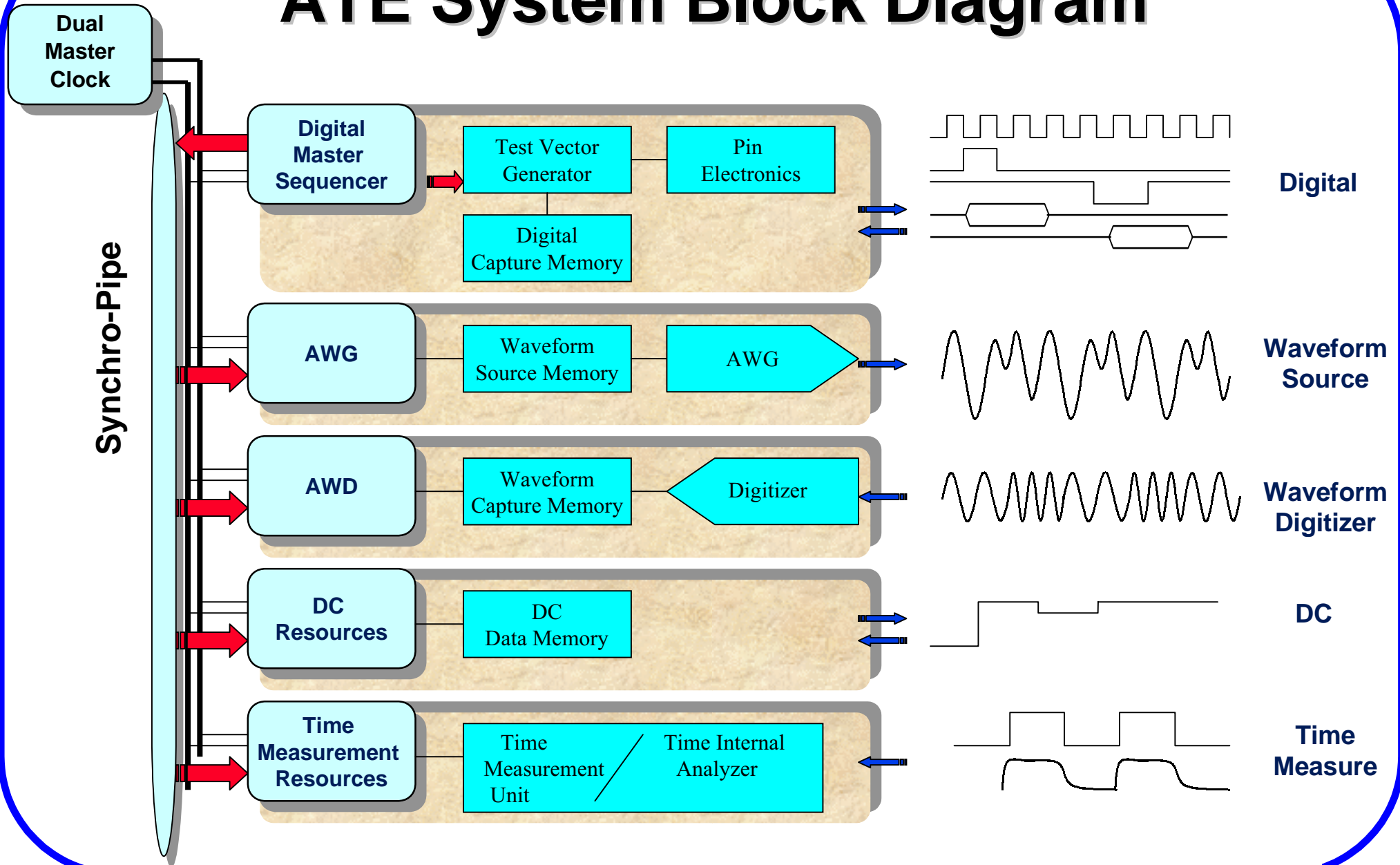
**LCD Drive/Panel Test System** - LCD Drive IC, Looking straight type..... **T7313 LCD Drive/Panel Test System**

**E-Beam Test System** - ..... **E1380A E-Beam Test System**

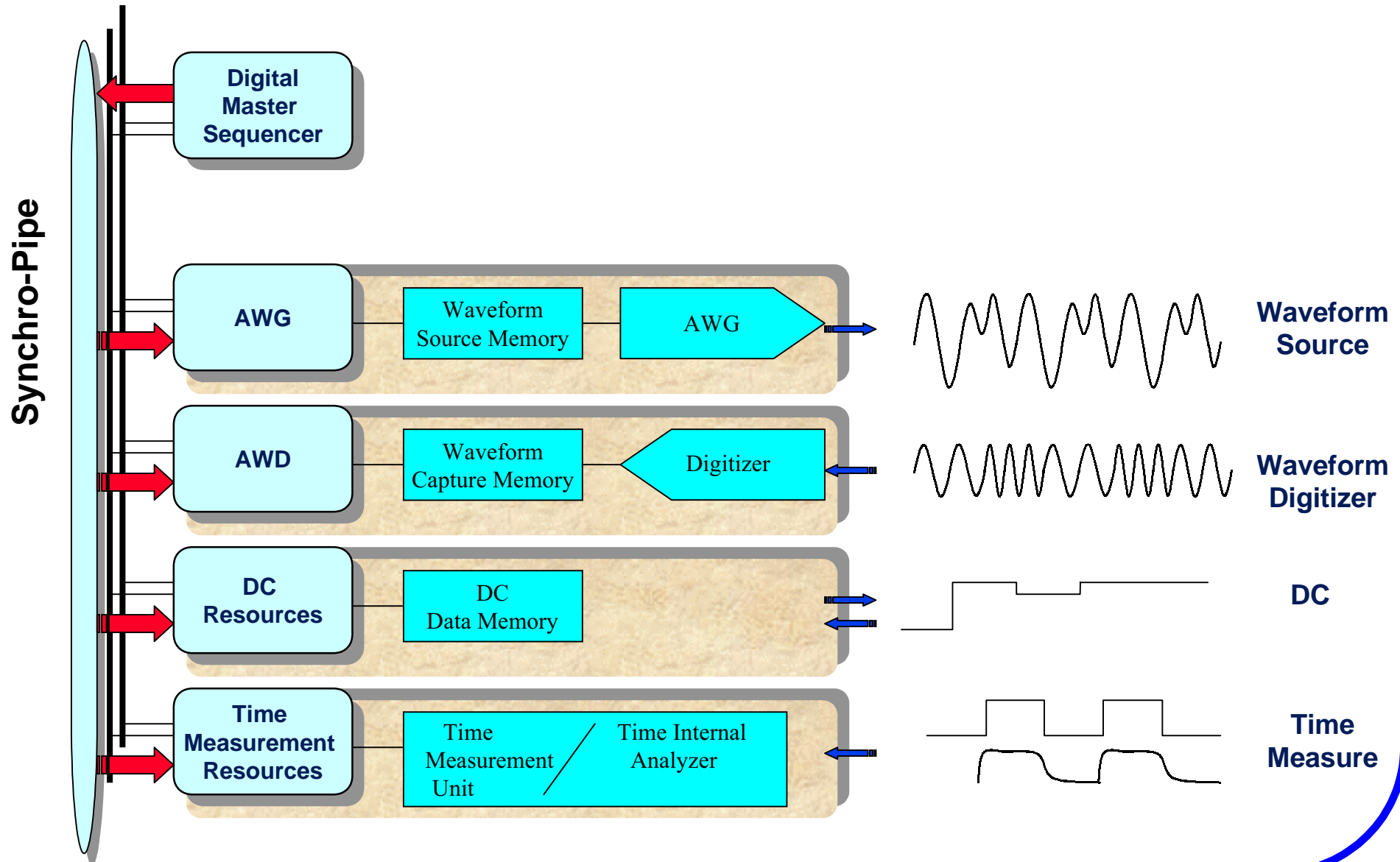
# Market share of Testers



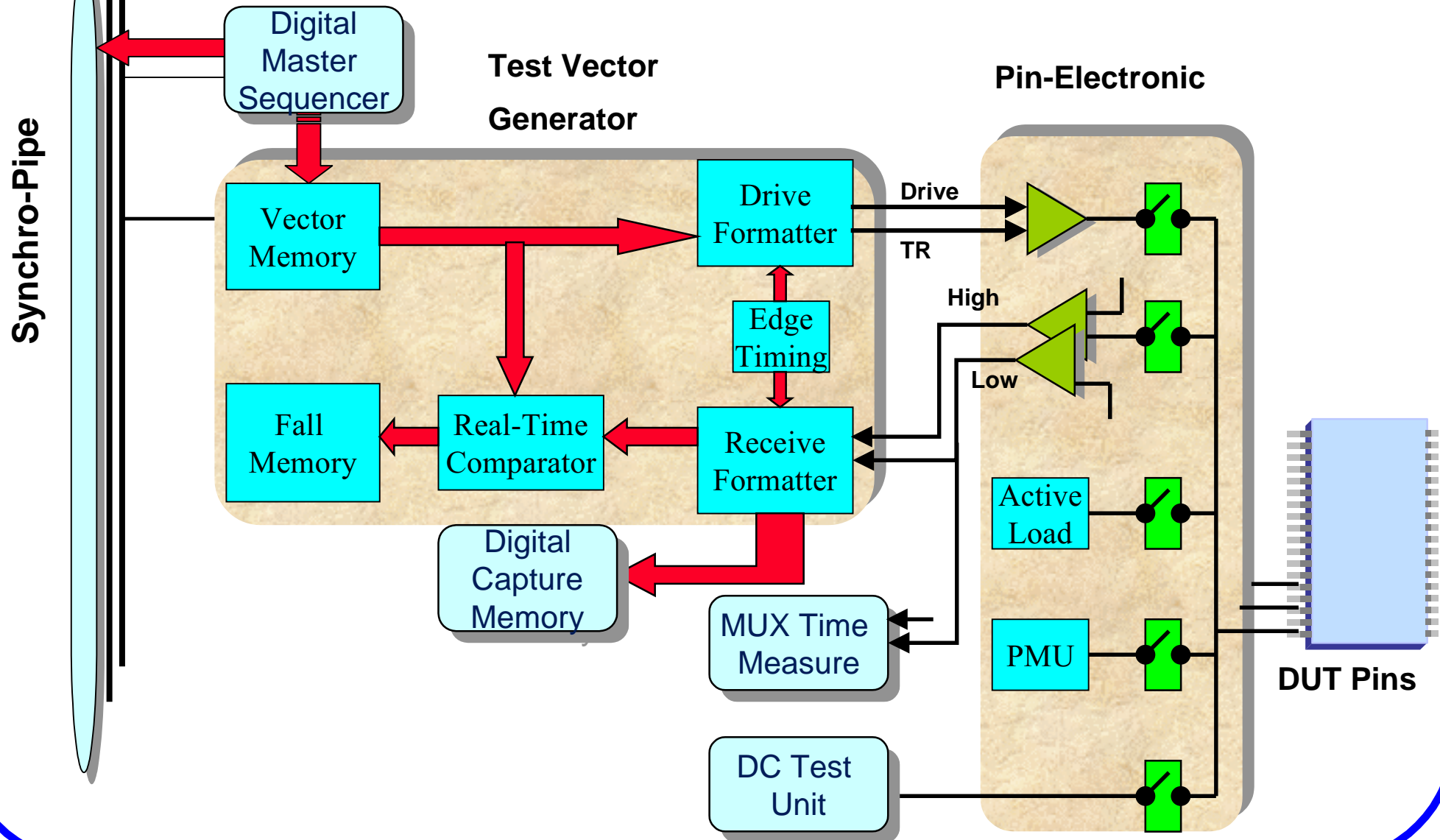
# ATE System Block Diagram



# Digital Test function Diagram



# Digital Test function Diagram





# DC Resources

**PPU**  
Per-Pin-DC Test  
Unit

8-256

-7 to +8V +/-30mA  
-2.1 to +7V +/-30mA

Fast Compare

**PPU**  
Parametric  
Measurement Unit

0-4(+1)

+/-40V 50mA or  
+/-20V 100mA

MUX to Pin or  
Direct

**PPU**  
Wide Range DC  
Test unit

0-3

+/-200V +/-50mA to  
+/- 2V +/- 1A

Low 1 Measure  
High V Force

**DPS**  
DUT Power Supply

1-2p  
Head

+/-6 to +/-24V 600mA  
+/-2 to +/- 8V 2A

DUAL  
Supplies

**PVS**  
Precision Voltage  
Source

0-1

+/-10V +/-100mA

23 bit  
Resolution

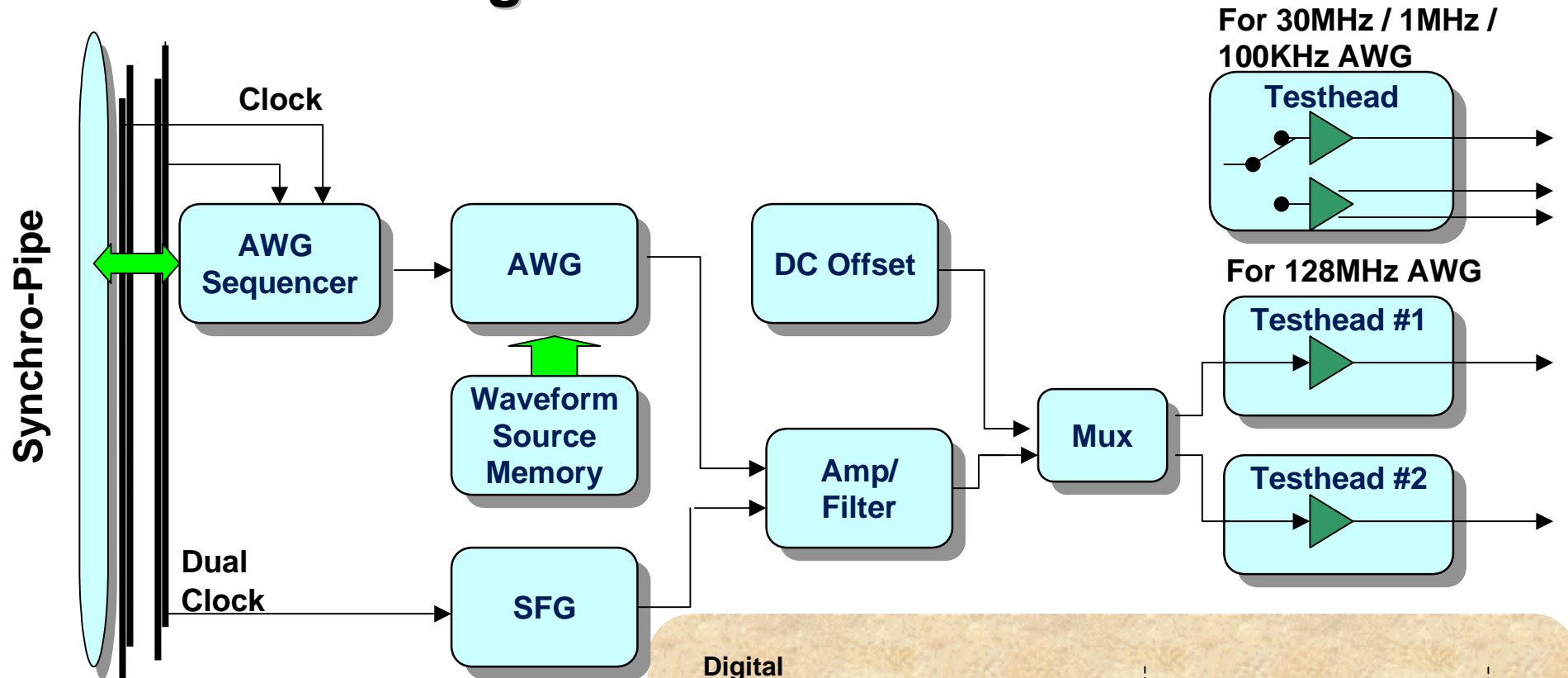
**PVM**  
Precision Voltage  
Measure

0-1

+/-10nV to +/- 200V

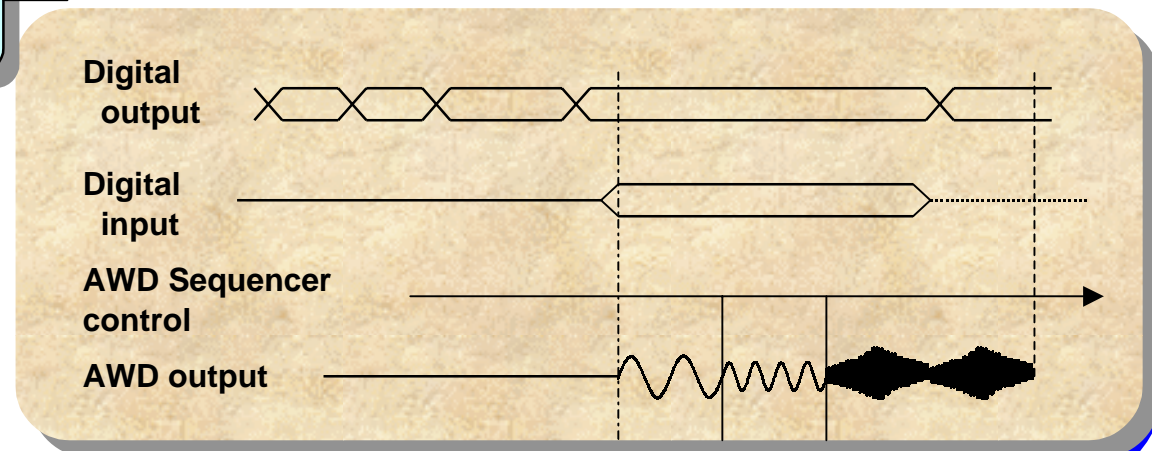
28 bit  
Resolution

# Analog Waveform Generation

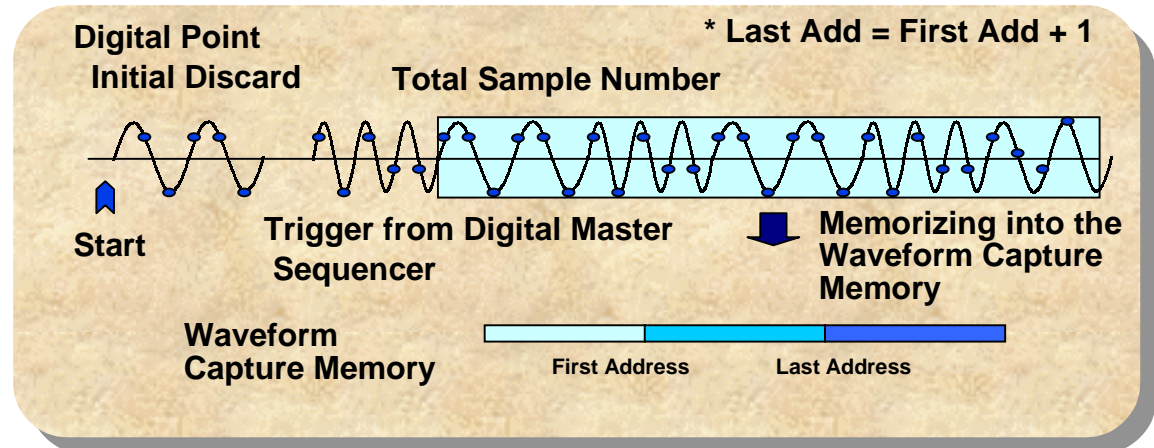
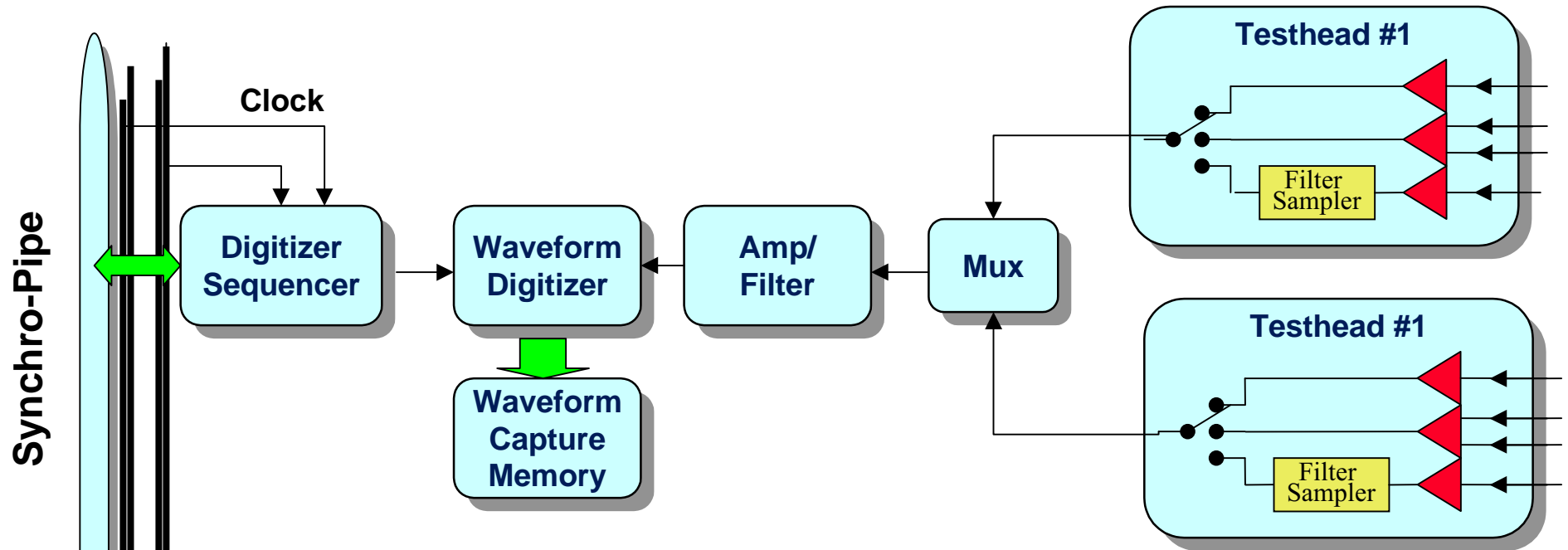


## Full Feature Set

- Synchronous or Asynchronous Clocking
- Triggering
- Waveform Sequencing
- Single-Ended or Differential
- Filters
- Offset
- Real-Time DSP



# Analog Waveform Digitization



# Time Measurement Resources

## TM Time Measurement Unit

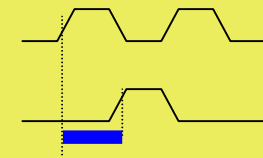
### Measurement:

- Max. 100MHz interval/period
- Max. 10ps resolution (interval)
- Max. 10fs resolution (period)
- One shot or averaging

### Single Channel



### Dual Channel

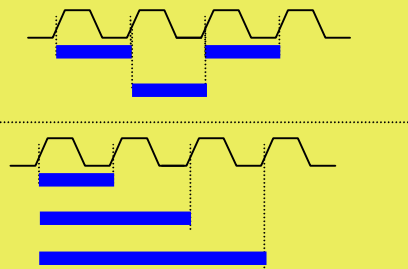


## TIA Time Interval Analyzer

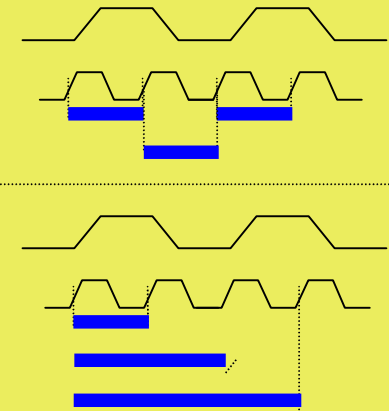
### Measurement:

- Max. 80MHz interval
- Max. 50ps resolution
- Multiple sequential(max. 2<sup>nd</sup>)
- Hardware histogram functions

### Single Channel

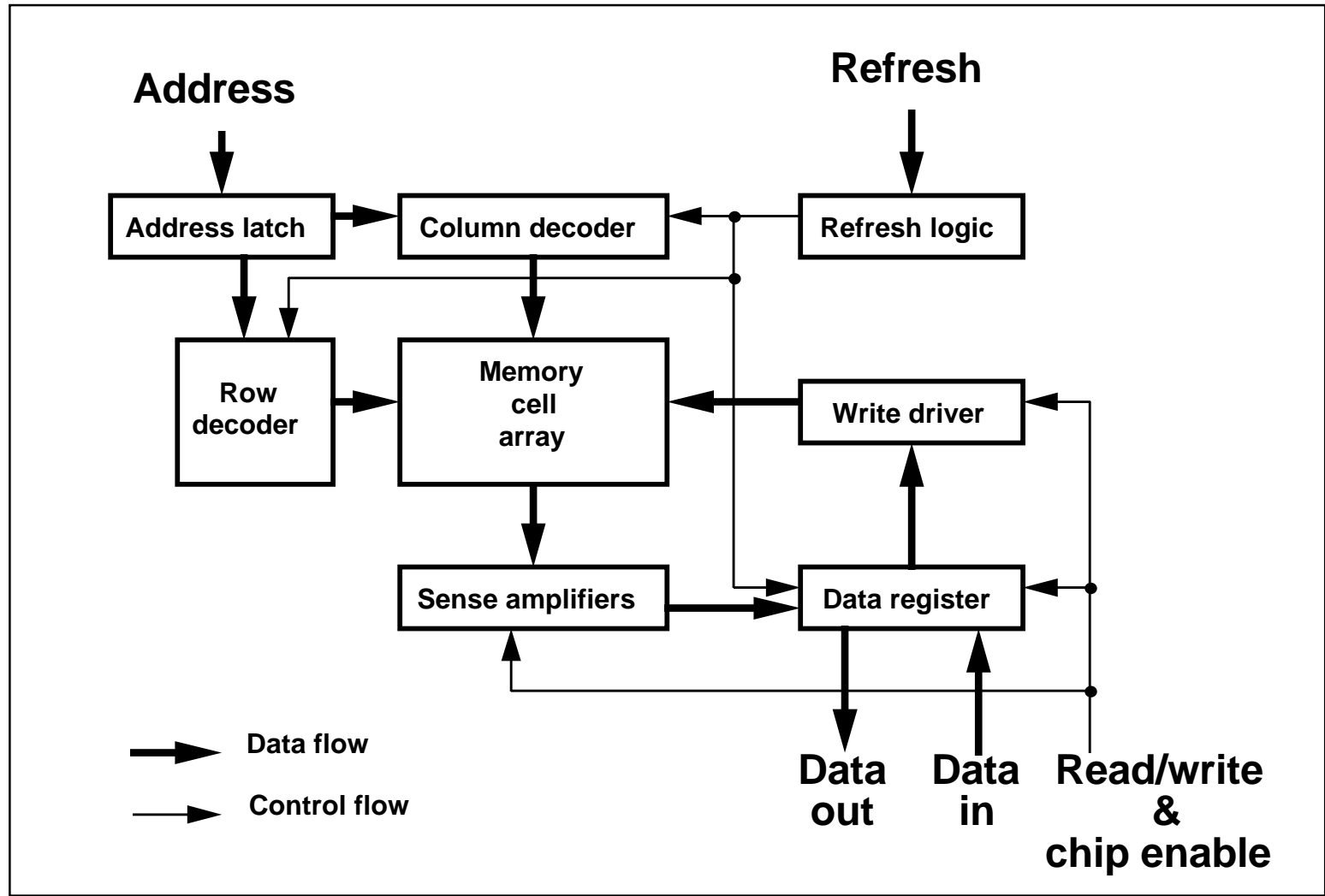


### Dual Channel



# Test Example -- DRAM

## Architecture of DRAM



# Test Program / Test Flow

- **Main program**
  - **Set Test Conditions**
    - » **Timing setup**  
Test Rate, Drover Clock, I/O Drive Enable clock....
    - » **Voltage setup**  
Driver, Comparator, Terminator, Program Load, Device power, DC Measure Unit.....
    - » **Pin Status setup**  
Pin => Voltage, Timing, Waveform, Pattern Assignment
  - **Control Test Sequence**
    - » **Timing Setup Hardware Unit Starting Flow**
    - » **Path Pattern Program to PG**
    - » **Read Control Data**

# Test Program / Test Flow (Cont. )

- » Call PBDATA
- » Timing guardband
- » Setting Category and Sort Table
- Start Program
  - » Measure DC
  - » Measure AC
  - » Functional Test
- Pattern program
  - Edit ALPG micro-code to process Test Pattern
- Socket program
  - Parallel Test Setup

# Test Principle / Test Module

## Items to Test for Memory IC

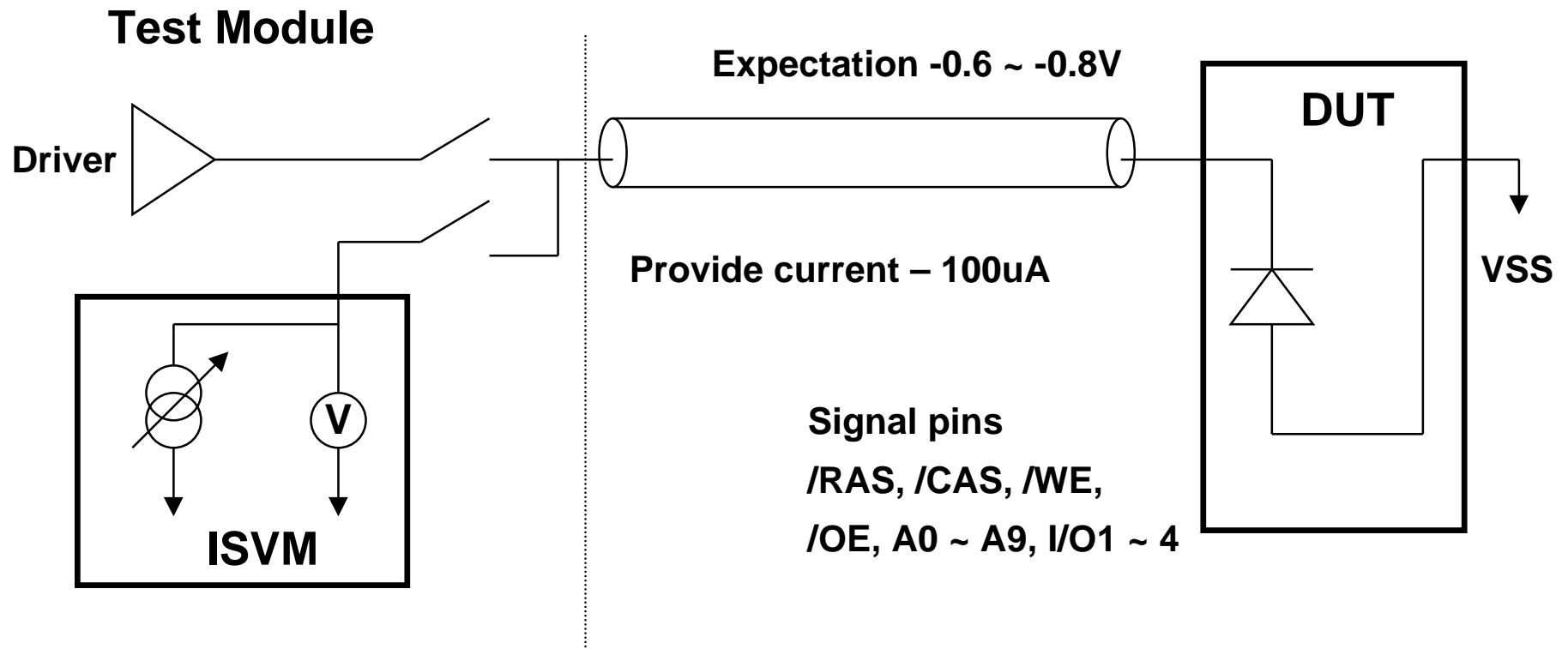
- **DC Parametric Test**  
Measure IC's DC Voltage or current
- **AC Parametric Test**  
Measure IC's AC Timing for Specification
- **Functional Test**  
Verify IC's operation functions



# DC Parametric Test

## 1. Open/Short Test ( Contact Test )

### a. Signal Pin Open/Short Test



# DC Parametric Test (Cont.)

## Program Example

**;OPEN/SHORT TEST (SINGAL PINS)**

**PCON= 0 ; 10uF Bypass Capacitor is disconnected**

**VCON= 1 (or VSI) ; The Relay of PPS is disconnected**

**LCON= 0 ; Power Supply of Load Module is disconnected**

**ISVM= -100UA,R800UA, M8V, 1V, -5V**

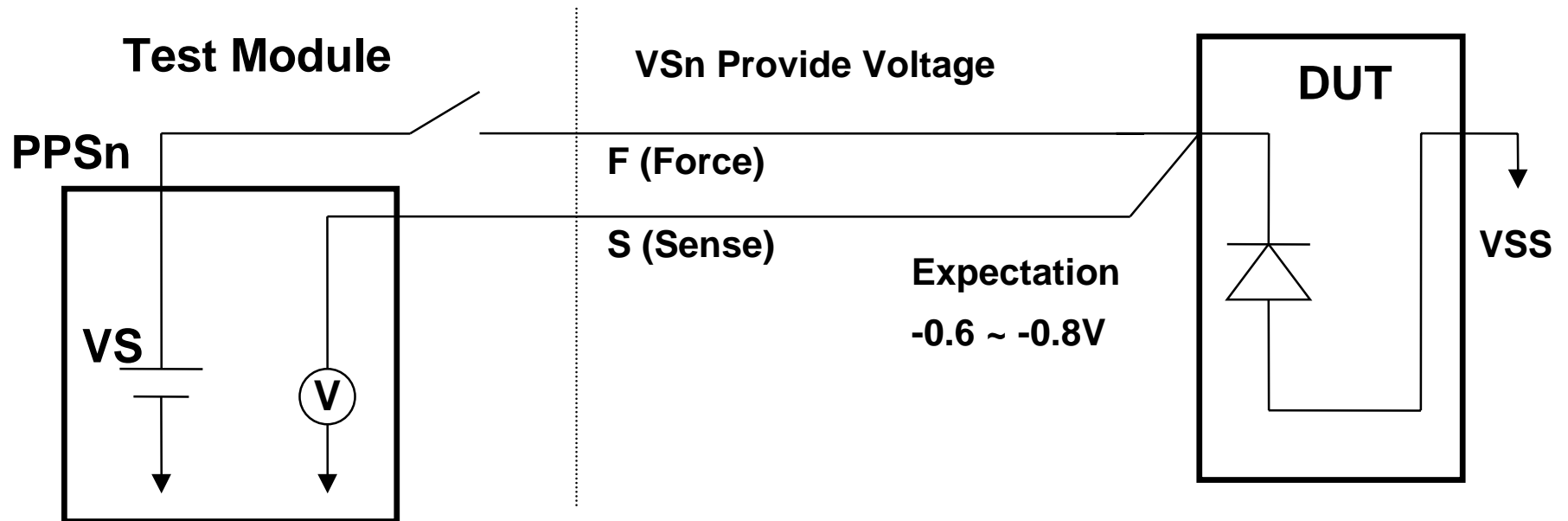
**LIMIT DC=-0.0IV, -2V**

**TEST 10**

**MEAS/T DC(pin number)**

# DC Parametric Test (Cont.)

## b. VCC Pin Open/Short Test



**;OPEN/SHORT TEST (VCC PINS)**

**VCON= I**

**; The Relay of PPS is disconnected**

**VS1=VSVM, -1V, R10V**

**LIMIT VS1=-0.3V, -0.7V**

**TEST 20**

**MEAS VS1**

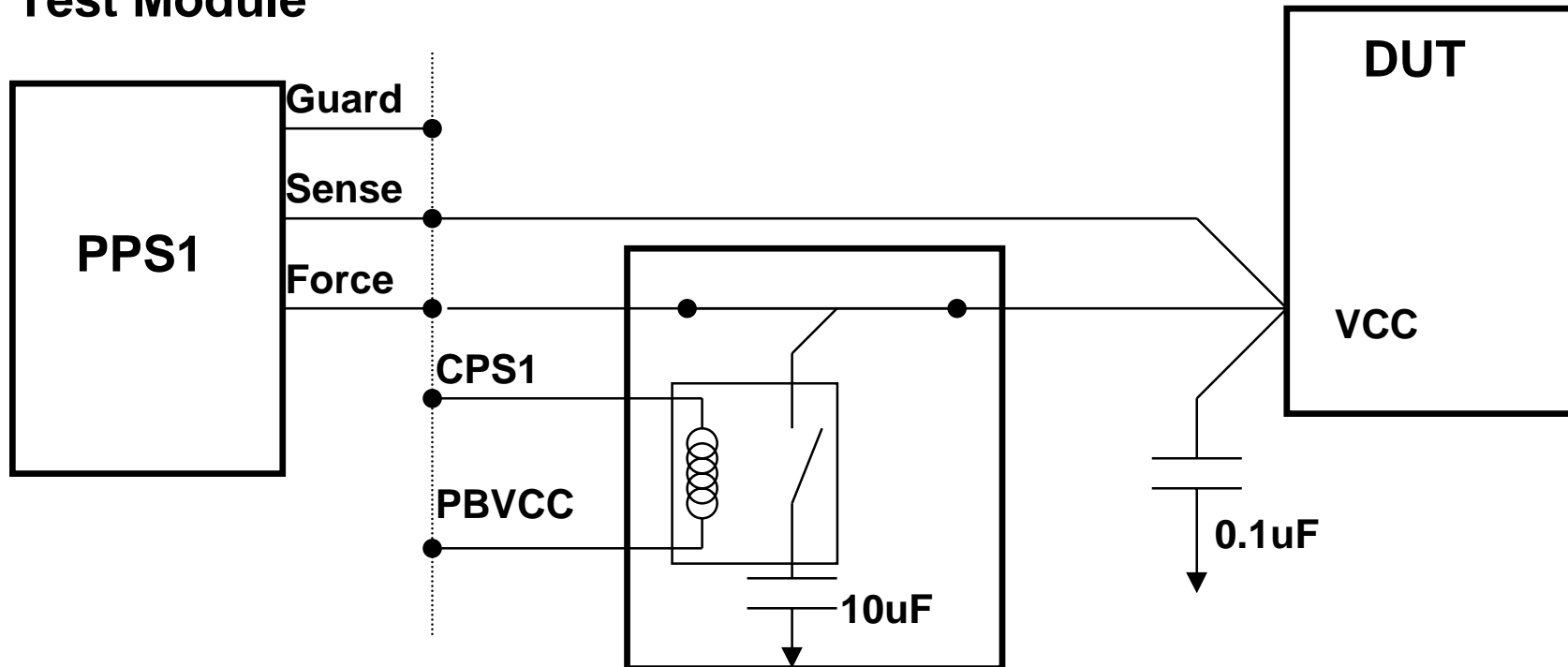
# DC Parametric Test (Cont.)

## 2. Standby ICC Current Test

### Test Status

**/RAS : High level,      /CAS : High level      I/O pins : Open,**  
**10uF C : OFF,              Limit : 2mA**

### Test Module



# DC Parametric Test (Cont.)

## Program Example

```
; STANDBY CURRENT ICC(ICC2)
PCON=0           ;10uF Capacitor is disconnected
VCON=0           ;The relay of PPS1 is connected
LCON=0           ; Power Supply of Load Module is disconnected
TIME1?MS: VSI
TIME2?MS: INI
;*****Power Supply Setting & *Pin Condition Setting
VS1=5.5V,R8V,M400MA ;Vcc maximum value
LIMIT VS1= 1MA,0   ;Maximum value of ICC2
INI=5.3V,OV        ;CMOS interface(High level=VCC-0.2V)
RAS=IN1,FXH       ; /RAS is high level
CAS=IN1,FXH       ; /CAS is high level
ADR=IN1,FXH       ; Address Pins Level is "don't care"
WE=IN1, FIXH      ; /WE level is "don't care "
OE=INIJXH        ; /OE level is "don't care"
IO=OPEN
;*****Test Item & Measure Start
SRON              ; Sequential Reference On happens
WAIT TIME 1MS    ; Wait until Vcc Current becomes stable
TEST 100
MEAS VS1         ; ICC2 value is measured
```

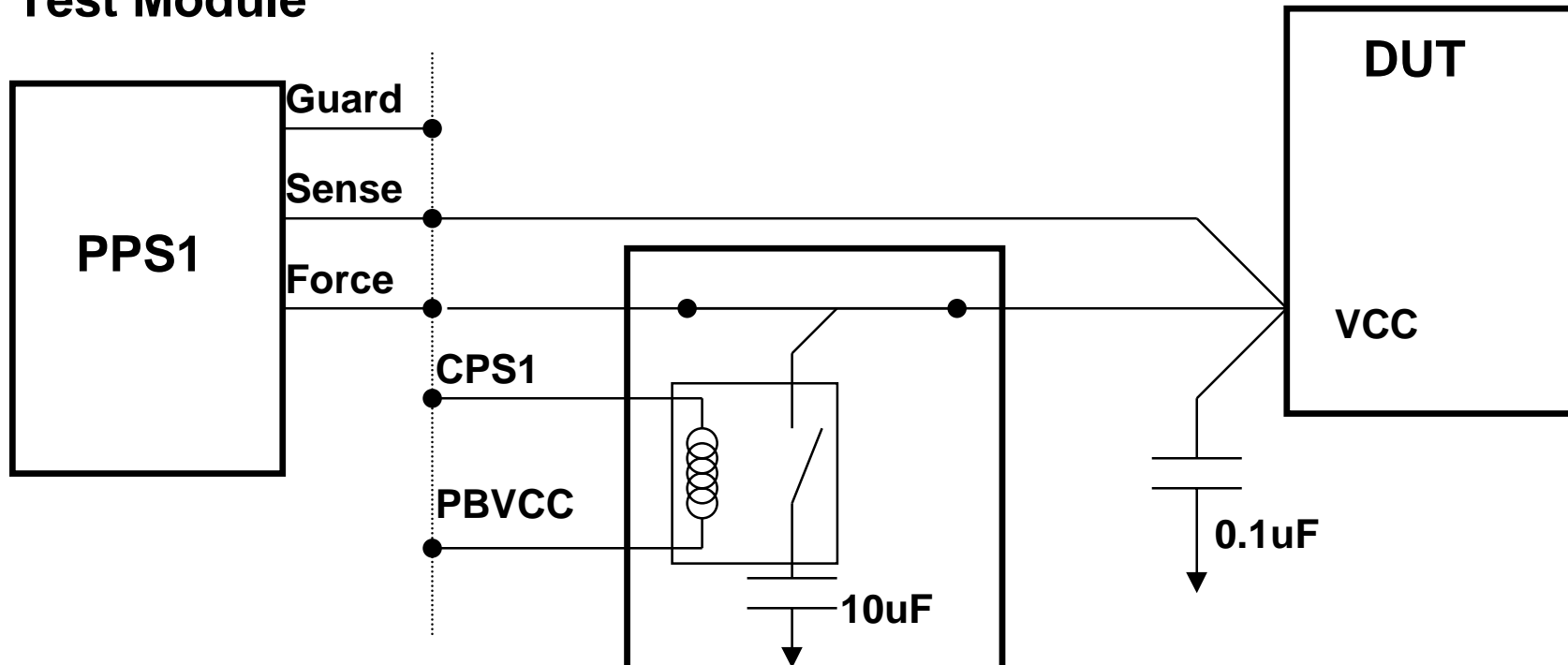
# DC Parametric Test (Cont.)

## 3. Operating ICC Current Test

### Test Status

/RAS : As SPEC,      /CAS : As SPEC      I/O pins : Open,  
10uF C : ON,      Limit : 2mA

### Test Module



# DC Parametric Test (Cont.)

## Program Example

```
;OPERATING CURRENT ICC(ICC3)
;*****pm Condition Setting
ADR=IN1, FIXL
RAS=IN1, /RZO,BCLK4,CCLK4,<CO>      ; /RAS Signal Definition
CAS=IN1, /RZO,BCLK5,CCLK5,<C1>      ; /CAS Signal Definition
WE=IN1, FIXL
OE=IN1, FIXH
IO=OPEN
;*****Power Supply Setting, PG Start & Test Item Set
PCON=1                                ;10uF Bypass Capacitor is connected
VSI=5.5V,R8V,M400MA,200MA,-200MA     ;Vcc maximum value
LIMIT VS1=100MA,0                    ;Maximum value of ICC1
REG MPAT PC=#***
SEND MPAT filename                    ;Send the patterp program to ALPG
START MPAT *                          ; ALPG start to run
WAIT TIME 1MS                          ; Wait until Vcc Current becomes stable
TEST 120
MEAS VS I                              ;ICC I value is measured
SROF& STOP MPAT
```

# DC Parametric Test (Cont.)

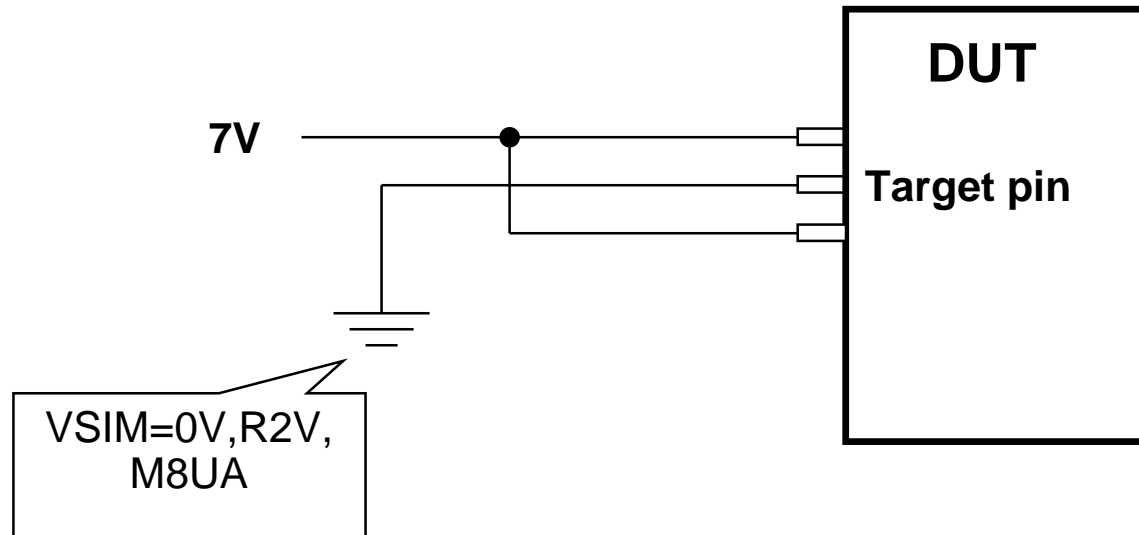
## 4. Current Leakage Test

### a. ILIL ( Input Leakage / Input Low )

#### Test Status

Vcc : 5.5V, 10uF C : OFF, Target input pin : 0V

The other input pins : 7V, I/O pins : Open, Limit : -10 ~ 10uA





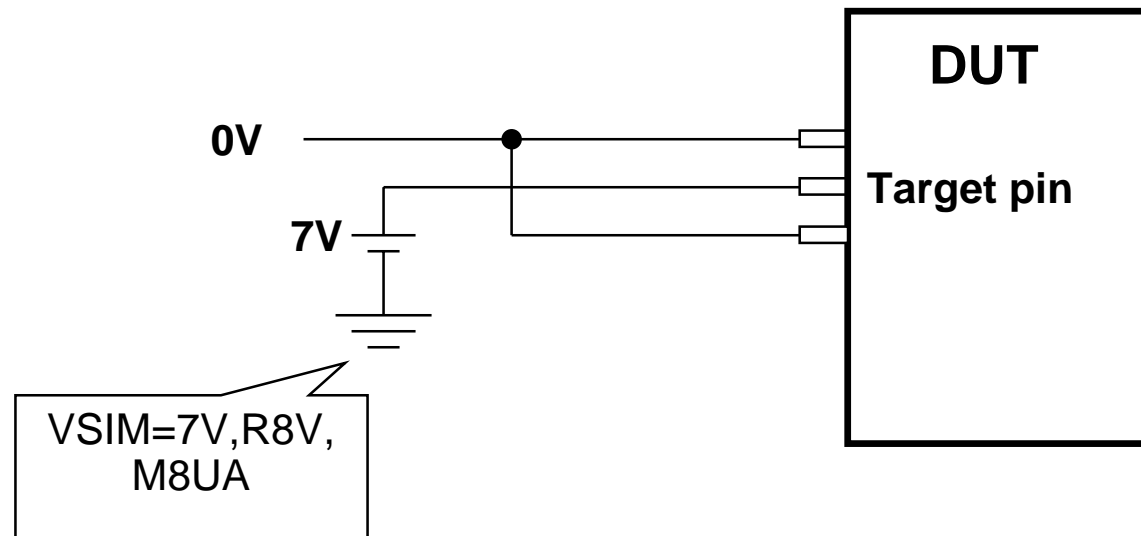
# DC Parametric Test (Cont.)

## b. ILIH ( Input Leakage / Input High )

### Test Status

V<sub>cc</sub> : 5.5V, 10uF C : OFF, Target input pin : 7V

The other input pins : 0V, I/O pins : Open, Limit : -10 ~ 10uA



# DC Parametric Test (Cont.)

## Program Example

**; INPUT LEAKAGE CURRENT TEST**

**VSI=5.5V**

**INI=7V,OV**

**IO=OPEN**

**VSIM=0V,R8V,M80UA,+112UA,-112UA**

**;Low level for a target input pin**

**LIMIT DC=IOUA,-IOUA**

**INP=IN1,FIHX**

**;High level for other input pin**

**TEST 140**

**MEAS DC(INP)**

**;ILIL is measured**

**VSIM=7V,R8V,M80UA,+112UA,-112UA**

**;High level for a target input pin**

**INP=IN1, FIXL**

**;Low level for other input pin**

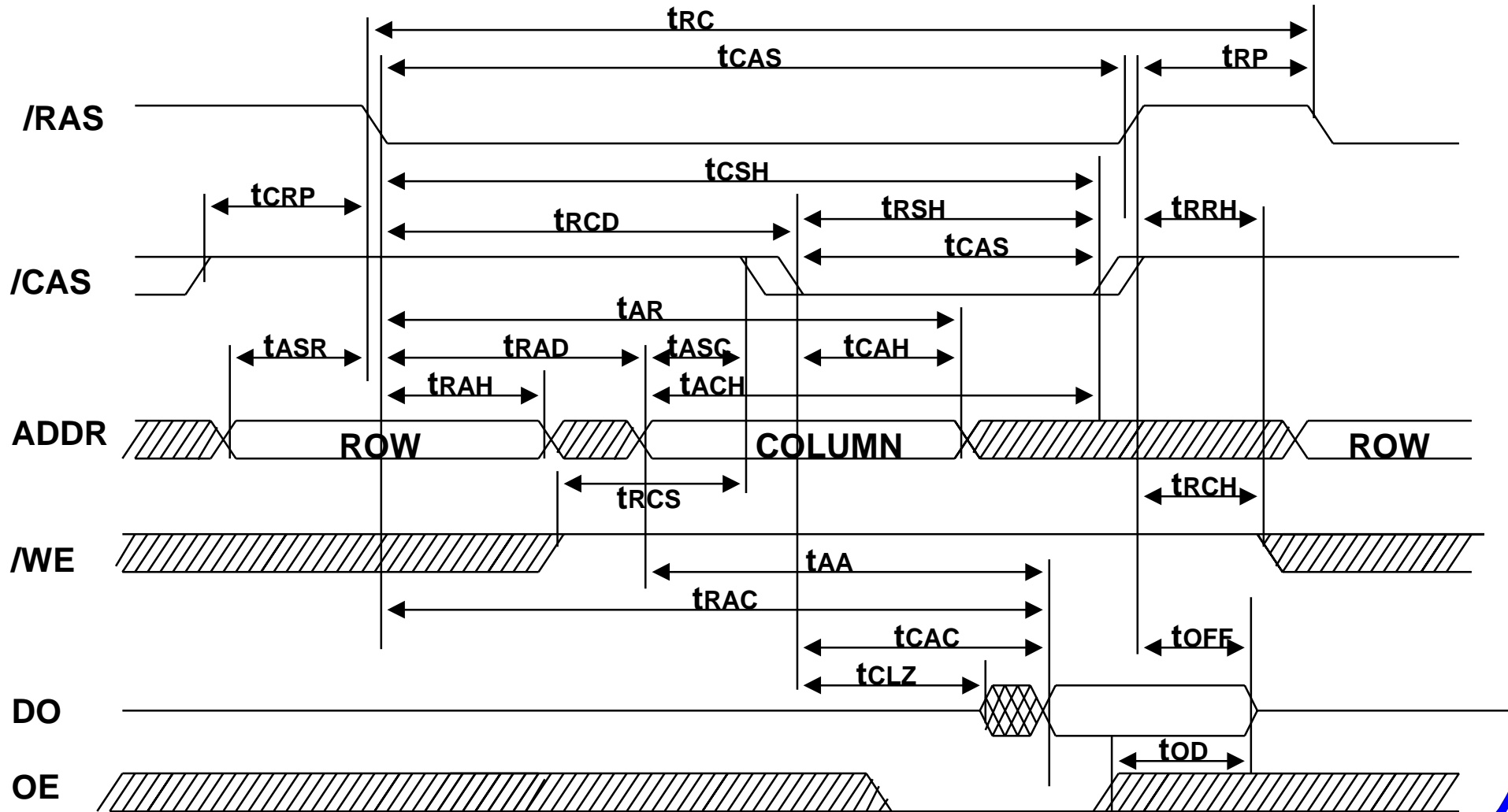
**TEST 150**

**MEAS DC(INP)**

**;LIH is measured**

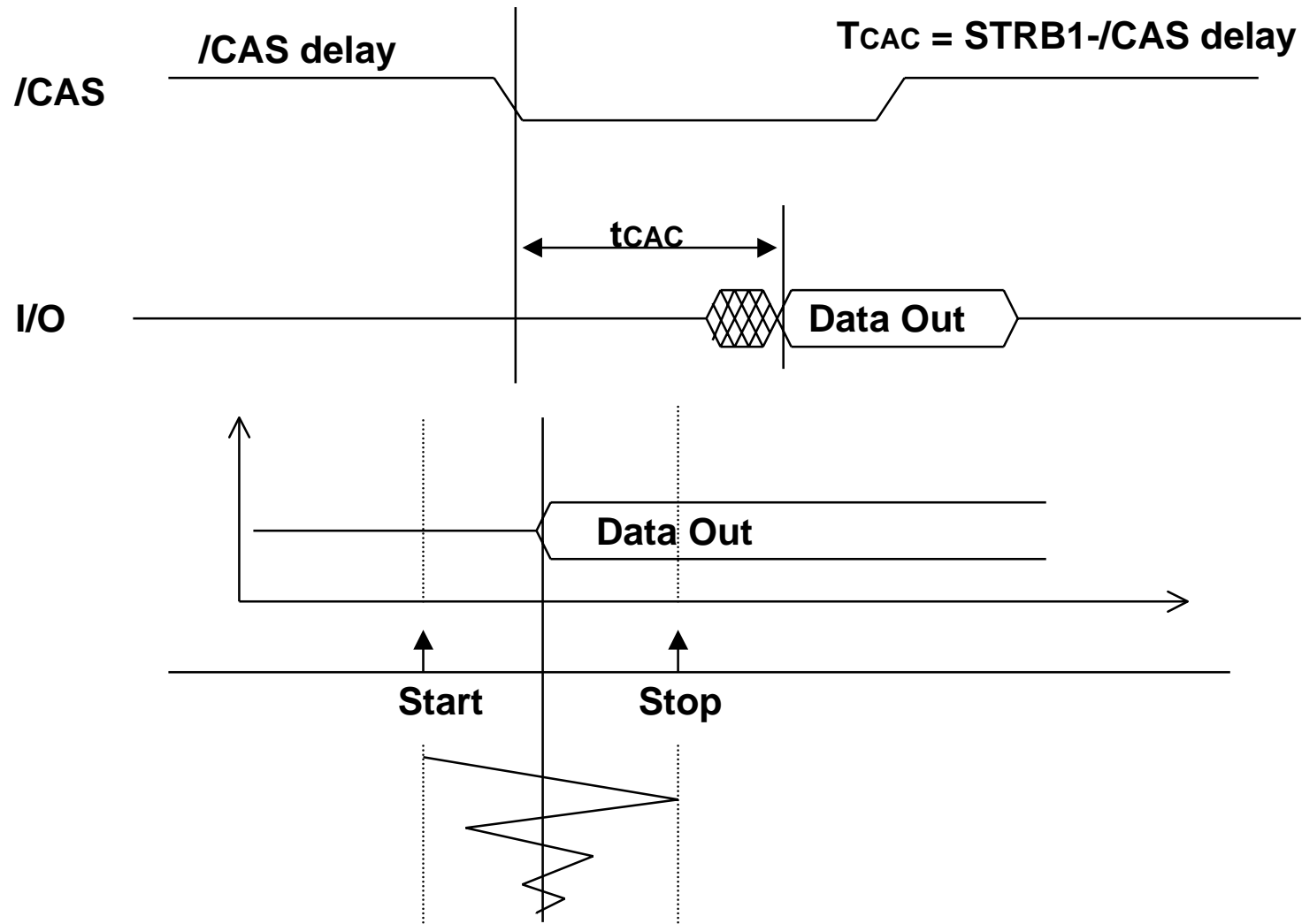
# AC Parametric Test

## Example : T<sub>CAC</sub> Test



# AC Parametric Test (Cont.)

## Example : $T_{CAC}$ Test



# AC Parametric Test (Cont.)

**;TCAC MEASUREMENT**

**DIM ARG(11) ;Elcvcn array variable arc required for the TMEAS utility.**

**;\*\*\*\*\*Voltage Setting**

**VSI=5.5V**

**OUTI=2.4V,0.8V**

**IN1=3V,OV**

**;\*\*\*\*\* Timing Edge Setting**

**RATE=260NS**

**ACLK1=30NS & BCLK1=45NS & CCLK1=70NS**

**ACLK2=75NS & BCLK2=80NS & CCLK2=115NS**

**ACLK3=0NS & BCLK3=80NS & CCLK3=115NS**

**ACLK4=0NS & BCLK4=50NS & CCLK4=190NS**

**ACLK5=0NS & BCLK5=85NS & CCLK5=190NS**

**ACLK6=0NS & BCLK6=50NS & CCLK6=190NS**

**ACLK7=0NS & BCLK7=80NS & CCLK7=115NS**

**DREL1=80NS & DRET1=115NS**

**STRB1=120NS**

**SELECT DCLK ACLK1, BCLK1, CCLK1**

# AC Parametric Test (Cont.)

```
;*****Pin Condition Setting
PADR=IN1,XOR, ACLK1,BCLK1,CCLK1 ,SDM,<X0-9,Y0-9>
PRAS IN1, /RZ0, BCLK4,CCLK4,<CO>
PCAS =IN1, /RZ0, BCLK5 ,CLK5,<CI>
PWE = IN1,/RZ0, BCLK7, CCLK7,<WT>
POE = IN1,/RZO,BCLK6,CCLK6,<RD>
PIO IN1, XOR,ACLK3,BCLK3,DRERZ,IOC,OUT1,STRB1,LOD,<D0-3>
;*****parameter Setting
ARG(1 )=0NS      ;Start value of ARG(3)'s unit
ARG(2)=120NS    ;Stop value of ARG(3)'s unit.
ARG(3)=21       ;Unit number (21;STRBI).
ARG(6)=1        ;Timing set number 1;TS!
ARG(7)=#0       ;Start PC value of ALPG.
ARG(8)=0        ;Tracking unit number.
ARG(9)=0        ;Tracking value for ARG(8).
ARG(10)=0       ;Timing set number of the tracking unit defined by ARG(8)
ARG(11)=1       ;DUT number.
;*****Test Item Set & Call Utility Function
REGMPATPC=#0
SEND MPAT filename
TEST 200
ASM TMEAS(ARG) ;TCAC is measured.
```

# Functional Test

## 1. Gross function Test

- Read Cycle Test
- Write Cycle Test
- Fast Page Mode / EDO Mode Check
- March Column / March Row

## 2. Special Pattern Test

- Checkboard Pattern
- Butterfly Pattern
- Diagonals Pattern
- Moving Inversion Pattern

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